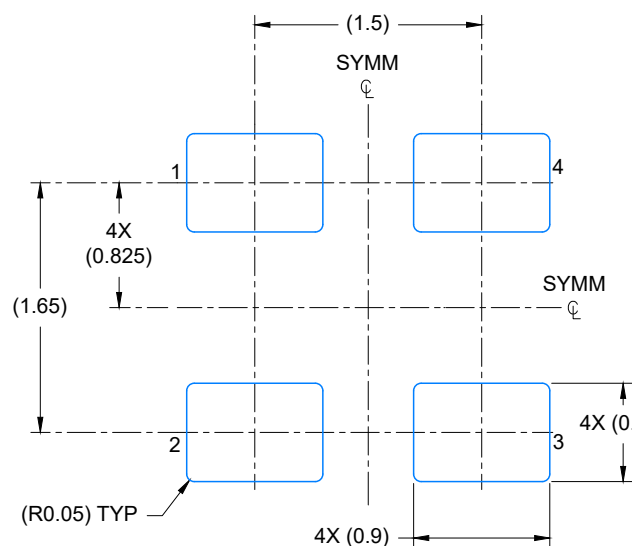


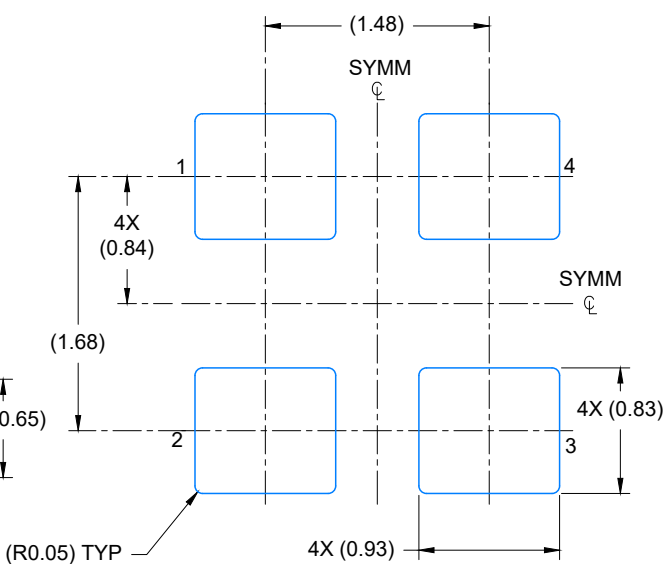
4225946/E 08/2025

## NOTES:

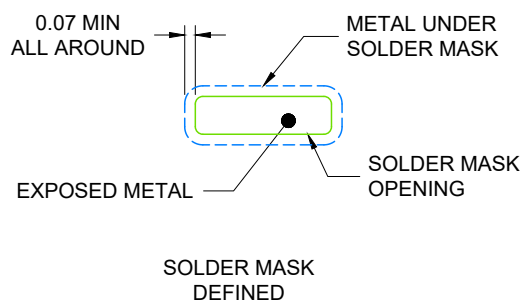
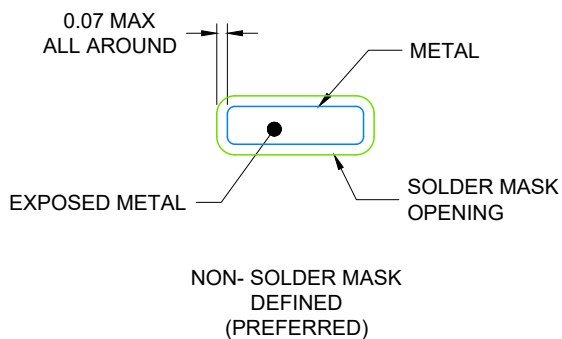
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 20X



UNIVERSAL LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 20X

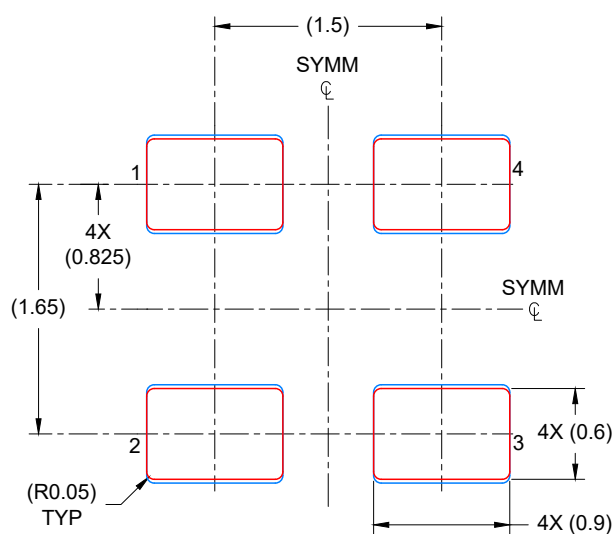


### SOLDER MASK DETAILS

4225946/E 08/2025

NOTES: (continued)

- For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sluea271](http://www.ti.com/lit/sluea271)) .

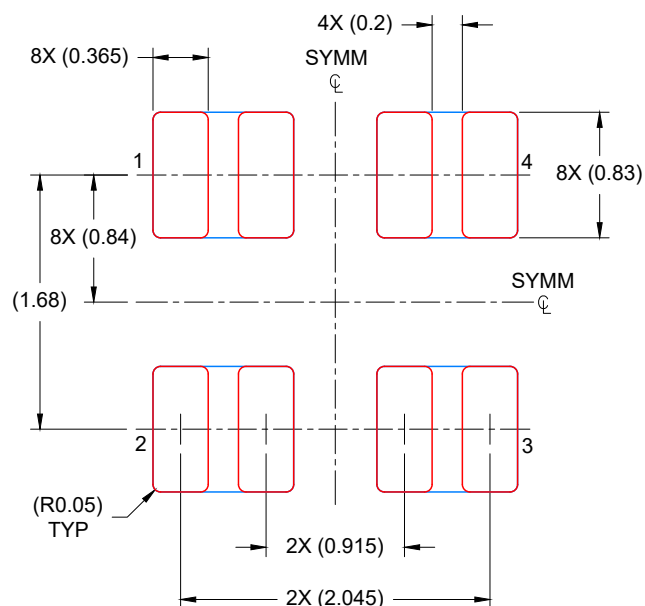


**SOLDER PASTE EXAMPLE**  
BASED ON 0.125 mm THICK STENCIL

PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE

ALL PADS: 92%

SCALE: 20X



**UNIVERSAL SOLDER PASTE EXAMPLE**  
BASED ON 0.125 mm THICK STENCIL

PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE

ALL PADS: 78%

SCALE: 20X

4225946/E 08/2025

NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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